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SEMI-AUTOMATIC TUNGSTEN CARBIDE DIE WORKING MACHINES

ETC-1/HF:

Special internal semi-automatic grinding <u>and</u> polishing machine for processing both the reduction cone as well as the cylindrical bearing of round tungsten carbide drawing dies in record-time.

Both these processes are completed in a single machine work cycle, greatly improving die processing throughput.

Work range: 0.70 - 20 mm Ø (.03 - .78" Ø)



ETC-2/LS CONTROL OF THE PART O

ETC-2 LS:

High speed semi-automatic grinding machine for larger sized round tungsten carbide dies. Concepted like the smaller ETC-1/HF unit, but showing a more rigid carriage, a larger 3-jaw chuck of 125 mm Ø, and a very robust, low -noise HF electric workspindle.

Model **ETC-2 LS** is an ideal machine for both the production and/or repair of large tc dies.

Work range: $1.0 - 40 \text{ mm } \emptyset (.40^{\circ} - 1.57^{\circ})$

TUNGSTEN CARBIDE DIE POLISHING MACHINES:

HPM:

Compact Hand Polishing unit with safety protection cover, two selectable rotary speeds, electric break and a 3-Jaw chuck to take up die-casings up to max. 100 mm Ø. (4").

<u>HPM-L</u>:

Rigid Hand Polishing unit, also featuring a safety protection cover, two selectable rotary speeds, electric brake and a larger 3-Jaw chuck, allowing to take up large die-casings of up to even $160 \text{ mm } \emptyset$. (6,5).

